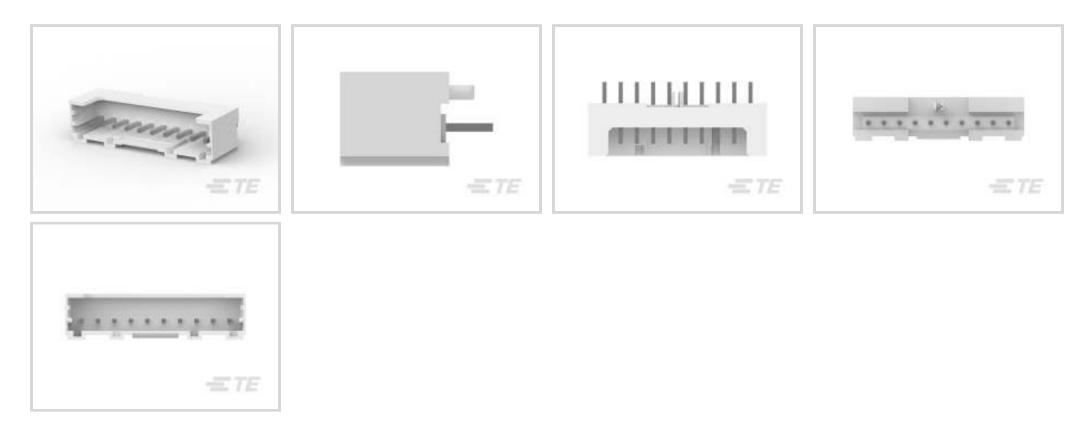


GRACE INERTIA 2.0

TE Internal #: 1971032-1 PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2 mm [. 079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 10

Number of Rows: 1

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Vertical

Features

connectivity

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	10
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	50 VAC
Body Features	
Connector & Keying Code	A
Primary Product Color	Natural

PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



Contact Features

Mating Square Post Dimension	.5 mm[.02 in]
PCB Contact Termination Area Plating Material Thickness	2 µm[78.74 µin]
Contact Layout	Inline
Mating Tab Width	.5 mm[.02 in]
Contact Underplating Material Thickness	1 μm[39.37 μin]
Contact Mating Area Plating Material Thickness	2 μm[78.74 μin]
PCB Contact Termination Area Plating Material Finish	Bright
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Bright
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Tab
Contact Current Rating (Max)	2.2 A

Termination Features

Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	2.6 mm[.102 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
Mating Alignment Type	Keyed
Mating Retention	With
Mating Retention Type	Latch
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	With
PCB Mount Retention	Without
Housing Features	
Housing Material	Nylon 6/6 GF
Centerline (Pitch)	2 mm[.079 in]

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Dimensions

Connector Length	6 mm[.23 in]
Connector Height	6.35 mm[.25 in]
Connector Width	5.6 mm[.22 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Glow Wire Rating	Standard Part - Not Glow Wire
Agency/Standard	UL
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	200
Packaging Type	Package

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products

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will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



TE Part # 3-1971032-2 2POS HEADER ASSEMBLY FOR GIC 2.0 EV



TE Part # 1971032-8 8POS HEADER ASSEMBLY FOR GIC 2.0 EV TE Part # 1971032-9 9POS HEADER ASSEMBLY FOR GIC 2.0 EV



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Also in the Series | GRACE INERTIA 2.0





Wire-to-Board Connector Contacts(3)

Customers Also Bought



Documents

Product Drawings 10POS HEADER ASSEMBLY FOR GIC 2.0 EV

English

10POS HEADER ASSEMBLY FOR GIC 2.0 EV

English

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PCB Mount Header, Vertical, Wire-to-Board, 10 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, GRACE INERTIA 2.0



CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1971032-1_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1971032-1_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1971032-1_D.3d_stp.zip

English

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Product Specifications Application Specification English